

ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCI022E
DEPT.	For CI93 Series Connector System	PAGE:	1/3

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and inserted on specified size Tin coated jumper wire or single wire

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

MIL - STD - 1344 Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CI93 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings



REVIEWED :_	Alex	APPROVED :_	David	_ VERIFIED :_	<u>Sandy</u>	
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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		1A 100V AC (r.m.s.) 1A 150V DC
7.2	Contact resistance	Dry circuit of DC 20mV max., 100mA max.	Lass than 20 m Ω
7.3	Dielectric strength	When applied AC 800V1minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500V between adjacent terminal or ground	More than $1000 \text{ M}\Omega$

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG #24~#26 Tin coated jumper wire or AWG #24~#26 single wire, 5± 0.5 mm strip
8.2	Wire withdrawal force	Measure force to withdrawal using specified wire size at speed 25±3 mm per minute	600 gram min. per pin

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ/minute each 2 hours for X,Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Solder ability	Tin-Lead Process: Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5 ° C	Minimum: 90% of immersed area
9.4	Resistance to soldering heat	Tin-Lead Process: Soldering time: 5 ± 0.5 second Soldering pot: 240 ± 5°C	No damage
9.5	Heat aging	85± 2°C, 96 hours	No damage



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	ITEM	TEST CONDITION	REQUIREMENT
9.6	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.7	Temperature cycling	One cycle consists of: (1) -55 ⁺⁰ ₋₃ °C, 30 min. (2)Room temp. 10-15 min. (3) 85 ⁺³ ₋₀ °C, 30 min. (4)Room temp. 10-15 min.	Appearance: No damage Contact resistance: Less than twice of initial
9.8	Salt spray	Temperature: 35± 3°C Solution: 5± 1% Spray time: 48± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -25 to +85°C